## PATENT ASSIGNMENT

## Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

## **CONVEYING PARTY DATA**

Name	Execution Date
Chiung-Han Yeh	02/20/2009
Sheng-Chen Chung	02/20/2009
Kong-Beng Thei	02/20/2009
Harry Chuang	02/20/2009

## **RECEIVING PARTY DATA**

Name:	Taiwan Semiconductor Manufacturing Company, Ltd.	
Street Address:	No. 8, Li-Hsin Road 6	
City:	Hsin-Chu	
State/Country:	TAIWAN	
Postal Code:	300-77	

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12488960

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	24061.1144	
NAME OF SUBMITTER:	Liem T. Do	

**REEL: 022857 FRAME: 0486** 

**PATENT** 500892043

Total Attachments: 3

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PATENT REEL: 022857 FRAME: 0487

Docket No.: 2008-0507 / 24061.1144

Customer No.: 42717

#### ASSIGNMENT

WHEREAS,	we.
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(1)	Chiung-Han Yeh	of	No. 214, Dawu Street, North District Tainan City 704, Taiwan, R.O.C.
(2)	Sheng-Chen Chung	of	6F, No. 55-1, Jhuangjing 5th Street Jhubei City, Hsinchu County 302, Taiwan, R.O.C.
(3)	Kong-Beng Thei	of	No. 186, Nan-Kang Road, Pao-Shan Village Hsin-Chu Country, Taiwan, R.O.C.
(4)	Harry Chuang	of	18-59 Lane 85, Fu-Chuan Street

have invented certain improvements in

# METHOD FOR TUNING A WORK FUNCTION OF HIGH-K METAL GATE DEVICES

for which we have executed an application for Letters Patent of the United States of America,

of even date filed herewith; and
filed on 6-22-2009 and assigned application number 12/488,960; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

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AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:	Chiung-Han Yeh
Residence Address:	No. 214, Dawu Street, North District Tainan City 704, Taiwan, R.O.C.
Dated: Z/D0 '0'	Chang - Han Yeh Inventor Signature
Inventor Name:	Sheng-Chen Chung
	Residence Address: 6F, No. 55-1, Jhuangjing 5th Street Jhubei City, Hsinchu County 302, Taiwan, R.O.C.
Dated: -/->-/	Inventor Signature
Inventor Name:	Kong-Beng Thei
	No. 186, Nan-Kang Road, Pao-Shan Village Hsin-Chu Country, Taiwan, R.O.C.
Dated: /so 'c	Inventor Signature

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Inventor Name:

Harry Chuang

Residence Address:

18-59 Lane 85, Fu-Chuan Street Hsin-Chu City, Taiwan, R.O.C.

Dated: 2-20-2009

Inventor Signature

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**RECORDED: 06/22/2009** 

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